

# **Assurance Continuity Maintenance Report**

BSI-DSZ-CC-0395-2007-MA-02

Infineon Smart Card IC (Security Controller)
SLE88CFX4001P/m8835b18
SLE88CFX4003P/m8837b18
SLE88CFX3521P/m8857b18
SLE88CFX2921P/m8859b18
each with PSL V2.00.07
and specific IC Dedicated Software



Common Criteria Recognition Arrangement for components up to EAL4

from

# Infineon Technologies AG

The IT product identified in this report was assessed according to the *Assurance Continuity: CCRA Requirements*, version 1.0, February 2004 and the developers Impact Analysis Report (IAR). The baseline for this assessment was the Certification Report, the Security Target and the Evaluation Technical Report of the product certified by the Federal Office for Information Security (BSI) under BSI-DSZ-CC-0395-2007.

The change to the certified product is at the level of the included development, production and delivery sites, a change that has no effect on assurance. No changes of hardware or IC dedicated software are applied, the TOE version did not change.

Consideration of the nature of the change leads to the conclusion that it is classified as a minor change and that certificate maintenance is the correct path to continuity of assurance.

Therefore, the assurance as outlined in the Certification Report BSI-DSZ-CC-0395-2007 is maintained for this version of the product. Details can be found on the following pages.

This report is an addendum to the Certification Report BSI-DSZ-CC-0395-2007.

Bonn, 29 January 2009



## **Assessment**

The IT product identified in this report was assessed according to the *Assurance Continuity: CCRA Requirements* [1] and the Impact Analysis Report (IAR) [2]. The baseline for this assessment was the Certification Report of the certified product (Target of Evaluation, TOE) [3], the Security Target [4] and the Evaluation Technical Report as outlined in [3].

The vendor for the Infineon Smart Card IC (Security Controller) SLE88CFX4001P/m8835b18, SLE88CFX4003P/m8837b18. SLE88CFX3521P/ m8857b18. SLE88CFX2921P/m8859b18 each with PSL V2.00.07 and specific IC Dedicated Software, Infineon Technologies AG, submitted an IAR [2] to the BSI for approval. The IAR is intended to satisfy the requirements outlined in the document Assurance Continuity: CCRA Requirements [1]. In accordance with those requirements. the IAR describes (i) the changes made to the certified TOE, (ii) the evidence updated as a result of the changes and (iii) the security impact of the changes.

The Common Criteria assurance requirements

- ACM Configuration management (i.e. ACM AUT.1, ACM CAP.4, ACM SCP.3),
- ADO Delivery and operation (i.e. ADO DEL.2, ADO IGS.1) and
- ALC Life cycle support (i.e. ALC\_DVS.2, ALC\_LCD.2, ALC\_TAT.2),

are fulfilled for the audited sites of the TOE listed completely below:

Site	Address	Function
Altis-Toppan	Toppan Photomask, Inc.	Mask Center
	European Technology Center	
	Boulevard John Kennedy 224	
	91105 Corbeil Essonnes	
	Cedex, France	
Amkor	Amkor Technology Philippines	Module Mounting
	Km. 22 East Service Rd.	
	South Superhighway	
	Muntinlupa City 1702	
	Philipines	
	Amkor Technology Philippines	
	119 North Science Avenue	
	Laguna Technopark, Binan	
	Laguna 4024, Philipines	
Augsburg	Infineon Technologies AG	Development
	Secure Mobile Solutions	
	Alter Postweg 101	
	86159 Augsburg, Germany	
Bangkok	Smartrac Technology,	Inlay Antenna
	142 Moo 1	Mounting
	Hi-Tech industrial Estate,	
	Ban Laean, Bang,	
	Pa-In Phra na korn Si Ayatthaya,	
	13160 Thailand	
Bucharest	Infineon Technology AG	Development
	Bd. Dimitrie Pompeiu 6, Sector 2	
	020335 Bucharest, Romania	

Site	Address	Function
Dresden	Infineon Technologies Dresden GmbH & Co. OHG	Production
Diesden	Königsbrücker Str. 180	
	01099 Dresden, Germany	
Dresden-Toppan	Toppan Photomask, Inc	Mask Center
Droodon roppan	Rähnitzer Allee 9	mack come.
	01109 Dresden, Germany	
Erfurt	Assa Abloy Identification Technologies GmbH	Module Mounting with
	(former Sokymat GmbH)	Inlay Antenna
	In den Weiden 4b, 99099 Erfurt	Mounting
Graz / Villach / Klagenfurt	Infineon Technologies Austria AG	Development
Giaz / Villadii / Klayeillult	Development Center Graz	Bevelopment
	Babenbergerstr. 10	
	8020 Graz, Austria	
	Infineon Technologies Austria AG	
	Siemensstr. 2	
	9500 Villach, Austria	
	Infineon Technologies Austria AG	
	Lakeside B05	
	9020 Klagenfurt, Austria	
Großostheim	Infineon Technology AG, DCE, Kühne & Nagel	Distribution Center
Großostrieim	Stockstädter Strasse 10 - Building 8A	Distribution Center
Harriand	63762 Großostheim, Germany	Distaile etis a Coatea
Hayward	Kuehne & Nagel	Distribution Center
	30805 Santana Street	
	Hayward, CA 94544	
	U.S.A.	<del> </del>
Lustenau	New Logic Technologies AG, - A Wipro Company,	Development
	Millenium Park 6,	
	6890 Lustenau, Austria	<del>-</del>
Munich	Infineon Technologies AG	Development
	Am Campeon 1-12	
	85579 Neubiberg, Germany	
	Infineon Technologies AG	
	Otto-Hahn-Ring 6	
	81739 München (Perlach), Germany	
Regensburg-West	Infineon Technologies AG	Module Mounting Inlay
	Wernerwerkstraße 2	Antenna Mounting,
	93049 Regensburg, Germany	Distribution Center
	Smartrac Technology GmbH,	
	Wernerwerkstraße 2	
	93049 Regensburg, Germany	
Singapore	DHL Exel Singapore Pte Ltd	Distribution Center
	Richland Business Center 11	
	Bedok North Ave 4	
	Singapore	
Singapore Kallang	Infineon Technologies AG	Module Mounting
	168 Kallang Way	
	Singapore 349253	
Tokyo	Kintetsu World Express, Inc.	Distribution Center
	Tokyo Import Logistics Center	
	Narita Terminal	
	Tokyo, Japan	

Site	Address	Function
Wuxi	Infineon Technologies (Wuxi) Co. Ltd.	Module Mounting,
	No. 118, Xing Chuang San Lu	Distribution Center
	Wuxi-Singapore Industrial Park	
	Wuxi 214028, Jiangsu, P.R. China	

The change to the TOE is at the level of the evaluated and included sites. The product functionality did not change. Furthermore, the changes are not significant from the standpoint of security.

### Conclusion

The changes to the TOE are at the level of the included sites, those changes that have no effect on assurance. Examination of the evidence indicates that the changes required are limited to inclusion of the additional development and production sites as listed above. The Security Target [4] is still valid for the changed TOE. Consideration of the nature of the change leads to the conclusion that it is classified as a minor change and that certificate maintenance is the correct path to continuity of assurance.

Therefore, BSI agrees that the assurance as outlined in the Certification Report [3] is maintained for the product and the product versions SLE88CFX4001P/m8835b18, SLE88CFX4003P/m8837b18, SLE88CFX3521P/m8857b18, SLE88CFX2921P/m8859b18 each with PSL V2.00.07 and specific IC Dedicated Software for that the certificate BSI-DSZ-CC-0395-2007 also applies. This report is an addendum to the Certification Report [3].

### References

- [1] Common Criteria document CCIMB-2004-02-009 "Assuarance Continuity: CCRA Requirements", version 1.0, February 2004
- [2] IAR BSI-DSZ-0395-2007-MA-02, Infineon Smart Card IC (Security Controller) SLE88CFX4001P/m8835b18 SLE88CFX4003P/m8837b18 SLE88CFX3521P/m8857b18 SLE88CFX2921P/m8859b18 each with PSL V2.00.07 and specific IC Dedicated Software, Version 1.1, 21.01.2009, Infineon Technologies AG (confidential document)
- [3] Certification Report BSI-DSZ-CC-0395-2007 for Infineon Smart Card IC (Security Controller) SLE88CFX4001P/m8835b18, SLE88CFX4003P/m8837b18, SLE88CFX3521P/m8857b18, SLE88CFX2921P/m8859b18 each with PSL V2.00.07 and specific IC Dedicated Software, Bundesamt für Sicherheit in der Informationstechnik, 2007-04-27
- [4] Infineon Technologies AG, Security and Chipcard ICs, Security Target, SLE88CFX4001P / m8835, 29. November 2006, Version 1.6